

Features

HP ZBook 8 G1i 14 Mobile Workstation



Left

1	ACS & ALS Sensor	9	LED Indicator
2	Microphone (2)	10	USB Type-C® 20Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
3	IR Camera (optional)	11	USB Type-A 5Gbps signaling rate (Powered)
4	Webcam	12	RJ45 Ethernet port (standard)
5	Camera Shutter	13	Security lock slot (Integrated)
6	IR LEDs (optional)	14	Fingerprint reader / Power button
7	Webcam LED	15	Touchpad
8	Nano SIM card slot (Optional)		

Features



Right

- | | | | |
|---|---|---|------------------------------|
| 1 | HDMI 2.1 | 4 | Power Indicator LED |
| 2 | Thunderbolt™ 4 with USB Type-C® 40Gbps signaling rate
(USB Power Delivery, DisplayPort™ 2.1) | 5 | Headphone/mic combo jack |
| 3 | Thunderbolt™ 4 with USB Type-C® 40Gbps signaling rate
(USB Power Delivery, DisplayPort™ 2.1) | 6 | Smart Card Reader (Optional) |

Features

PRODUCT NAME

HP ZBook 8 G1i 14 Mobile Workstation

OPERATING SYSTEM

Preinstalled OS

- FreeDOS
- Windows 11 Home - HP recommends Windows 11 Pro for business ¹
- Windows 11 Home Single Language - HP recommends Windows 11 Pro for business ¹
- Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) ¹
- Windows 11 Pro ¹
- Linux Ubuntu 24.04

¹ Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on <http://www.support.hp.com>. A full list of HP products and the Windows 10 versions tested is available on the HP support website. <https://support.hp.com/us-en/document/c05195282>



Features

PROCESSOR

Name ^{1,2,3,4,5,7}	Cores	Number of P-cores	Number of E-cores	Number Of LP E-core	Threads	Smart Cache	Max Turbo Frequency		Intel SIPP/vPro® Enterprise	NPU	NPU TOPs
							P-cores	E-cores			
Intel® Core™ Ultra9 processor 285H	16 cores	6	8	2	16	24 MB	5.40 GHz	4.5 GHz	X	Intel® AI Boost	13
Intel® Core™ Ultra7 processor 265H	16 cores	6	8	2	16	24 MB	5.30 GHz	4.50 GHz	X	Intel® AI Boost	13
Intel® Core™ Ultra7 processor 255H	16 cores	6	8	2	16	24 MB	5.10 GHz	4.40 GHz		Intel® AI Boost	13
Intel® Core™ Ultra5 processor 235H	14 cores	4	8	2	16	18 MB	5.00 GHz	4.40 GHz	X	Intel® AI Boost	13
Intel® Core™ Ultra5 processor 225H	14 cores	4	8	2	16	18 MB	4.90 GHz	4.30 GHz		Intel® AI Boost	13
Intel® Core™ Ultra7 processor 265U	12 cores	2	8	2	14	12 MB	5.30 GHz	4.20 GHz	X	Intel® AI Boost	12
Intel® Core™ Ultra7 processor 255U	12 cores	2	8	2	14	12 MB	5.20 GHz	4.20 GHz		Intel® AI Boost	12
Intel® Core™ Ultra5 processor 235U	12 cores	2	8	2	14	12 MB	4.90 GHz	4.10 GHz	X	Intel® AI Boost	12
Intel® Core™ Ultra5 processor 225U	12 cores	2	8	2	14	12 MB	4.80 GHz	3.80 GHz		Intel® AI Boost	12

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

² Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

³ Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See <http://intel.com/vpro>

⁴ In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

⁵ Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

⁷ Features and software that require a NPU may require software purchase, subscription or enablement by a software or platform provider, and third party software may have specific configuration or compatibility requirements. Performance varies by use, configuration, and other factors.



Features

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Graphics (U Series Processors)

Intel® Arc™ 140T GPU (Ultra 7/9 H Series Processors)

Intel® Arc™ 130T GPU (Ultra 5 H Series Processors)

Discrete

NVIDIA RTX™ 500 Ada Laptop GPU (4 GB GDDR6 dedicated)

Supports

Support HDMI 2.1

DISPLAY

Internal

Non-Touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), LCD, UWVA, Anti-Glare, Low Blue Light, 800 nits, sRGB 100%, HP Sure View 5 [6]

35.6 cm (14") diagonal, WQXGA (2560 x 1600), Bent, LCD, 120Hz, UWVA, anti-glare, WLED, 500 nits, DCI-P3 100%, HP DreamColor

35.6 cm (14") diagonal, 2.5K (2560 x 1600), LCD, 120Hz (VRR), UWVA, Anti-Glare, WLED + Low Blue Light, 400 nits, Adobe 100% + DCI-P3 100%

35.6 cm (14") diagonal, WUXGA (1920 x 1200), LCD, UWVA, Anti-Glare, WLED + Low Blue Light, 400 nits, Low Power, sRGB 100%

35.6 cm (14") diagonal, WUXGA (1920 x 1200), LCD, UWVA, Anti-Glare, WLED, 300 nits, Low Power, sRGB 62.5%

Touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), LCD, Touch, UWVA, Anti-Glare, Low Blue Light, 800 nits, sRGB 100%, HP Sure View 5 [6]

35.6 cm (14") diagonal, WUXGA (1920 x 1200), LCD, Touch, UWVA, Anti-Glare, 300 nits, Low Power, sRGB 62.5%

DisplayPort™ 1.4

HDMI 2.0 Support resolution up to 4K @60 Hz

Displays support

Supports dual display through the dock



Features

Display Size

14.0"

35.6 cm

Docking (Sold Separately)

Docking station model #1

HP USB-C™ Dock G5

Total number of supported displays (incl.the notebook) display)

3

Max.resolutions supported

Multi-Function Mode: (2) 5k @ 30Hz and (1) 4k UHD @ 30Hz on any port
High-Resolution Mode: (2) 5k @ 60Hz on DisplayPort ports and (1) 4k UHD @ 60Hz on HDMI port

1x HDMI 2.0, 2x DisplayPort 1.4

Maximum resolution and display support is dependent on the maximum capability of the notebook.

Dock Connectors

Technicallimitations

Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode

The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

HP Thunderbolt™ 120W G4 Dock

4

Max.resolutions supported

Quad 4K @60Hz
Dual 8K single cable@30 for Thunderbolt hosts or USB-C hosts DisplayPort 1.4 with Display Stream Compression in High-Resolution Mode

2x HDMI 2.0, 2x DisplayPort 1.4, 1x Thunderbolt 4, 1x USB-C 3.2 Gen 2 DisplayPort

Maximum resolution and display support is dependent on the maximum capability of the notebook.

Dock Connectors

Technicallimitations

Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port



Features

Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

STORAGE AND DRIVES

Primary M.2 Storage

2 TB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell [6]

1 TB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell [6]

1 TB PCIe® NVMe™ SSD Value [6]

512 GB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell [6]

512 GB PCIe® Gen4x4 NVMe™ Self Encrypted OPAL2 SSD Three Layer Cell [6]

512 GB PCIe® NVMe™ SSD Value [6]

256 GB PCIe® NVMe™ Self Encrypted OPAL2 SSD Value [6]

256 GB PCIe® NVMe™ SSD Value [6]

MEMORY

Maximum Memory

64GB DDR5-5600 MT/s (2 x 32 GB) Memory

64GB DDR5-5600 MT/s (2 x 32 GB) Memory [8]

32GB DDR5-6400 MT/s (2 x 16 GB) Memory [8]

32GB DDR5-5600 MT/s (1 x 32 GB) Memory [8]

32GB DDR5-5600 MT/s (2 x 16 GB) Memory [8]

16GB DDR5-6400 MT/s (1 x 16 GB) Memory [8]

16GB DDR5-5600 MT/s (1 x 16 GB) Memory [8]

16GB DDR5-5600 MT/s (2 x 8 GB) Memory [8]

Memory Slots

2 SODIMM

System runs at up to 6400 MT/s

Supports Dual Channel Memory(optional).

The memory is accessible/upgradeable by IT or self-maintainers only



Features

NETWORKING /COMMUNICATIONS

WLAN

Intel® BE201 Wi-Fi 7 Bluetooth® 5.4 vPro® WW WLAN
Intel® BE201 Wi-Fi 7 Bluetooth® 5.4 non-vPro® WW WLAN
Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 vPro® WW WLAN
Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 WW WLAN

WWAN

HP 5G Sub-6 CAT19
HP 4G CAT19

LPWAN

Qualcomm 9205 LTE-M (CAT-M1 fSVC) [12]

NFC

NFC Mirage WNC XRAV-1

Miracast

Native Miracast Support

Ethernet

Intel® I219-LM (vPro®) GbE PCIe NIC

AUDIO/MULTIMEDIA

Audio by Poly Studio
2 Integrated stereo speakers
Discrete Amplifiers
2 Integrated dual array microphone

Speaker Power

1W / 8 ohm per speaker

Camera

5MP + Infrared camera
5MP camera

Sensors

Ambient Light Sensor
Color Sensor with Ambient Light Sensing



Features

Fingerprint Sensor (optional)

Hall Effect Sensor

HP Sure Platform

HP Tamper Lock [14]

Motion Sensor (select models)

Thermal Sensor

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium NB Keyboard, spill-resistant, backlit, Durakey keyboard.

HP Premium NB Keyboard, spill-resistant, Privacy, backlit, Durakey, keyboard.

Pointing Device

Clickpad

Microsoft Precision Touchpad Default Gestures Support

Multi-touch gesture support

Function Keys

ESC - System information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Blank or Keyboard Backlight

F6 - Audio Mute

F7 - Volume Down

F8 - Volume Up

F9 - Mic Mute

F10 - Play and Pause

F11 - Programmable Key

F12 - HOME

Power Button (with LED)

Insert

Delete

End

Page up

Page down

Microsoft Copilot [15]

Hidden Keys

Fn+R - Break, Fn+S - Sys Rq, Fn+C - Scroll Lock



Features

SOFTWARE AND SECURITY

Application Software

Buy Microsoft Office (Sold Separately)

HP Connection Optimizer

Edge Customization

HP Hotkey Support

HP Mac Address Manager

HP Notifications

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Privacy Settings

HP Services Scan [15]

HP Smart Support [16]

HP Support Assistant [17]

myHP

HSA Fusion for Commercial

HSA Telemetry for Commercial

Poly Lens [18]

Poly Camera Pro

Ubuntu Data Science Stack

Manageability Features

HP Client Catalog ([download](#)) [19]

HP Client Management Script Library ([download](#)) [20]

HP Cloud Recovery [21]

HP Connect for Microsoft Endpoint Manager

HP Driver Packs ([download](#)) [22]

HP Image Assistant ([download](#)) [23]

HP Manageability Integration Kit ([download](#)) [24]

HP Power Manager with Battery Health Manager ([download](#)) [25]

Security Management

Secured-Core PC Enable [26]

Windows Hello Enhanced Sign-In Security (ESS)

HP Wolf Security for Business which includes: [27]

HP Tamper Lock

HP Sure Admin [28]

HP Sure Click [29]

HP Sure Recover [30]

HP Sure Run [31]



Features

HP Sure Sense [32]
HP Sure Start [33]

BIOS

Absolute Persistence Module [34]

Audio Permanent Disable

HP BIOS Recovery

HP Fingerprint Sensor [35]

BIOS Update via Network

HP BIOSphere Gen6 [36]

HP DriveLock & Automatic DriveLock

HP Secure Erase [37]

HP Wake on WLAN

15. HP Services Scan is preinstalled and/or provided thru Windows Update and checks for service entitlement on each hardware device and downloads the applicable software agent automatically. To disable this feature, please follow the instructions at <http://www.hpdaas.com/requirements>. The HP Insights agent is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to the HP Insights agent is required. For full system requirements, please visit <http://www.hpdaas.com/requirements>. Not available in China.

16. HP Smart Support requires the HP Insights agent to be installed. For more information about how to enable or to download HP Smart Support, please visit <http://www.hp.com/smart-support>. HP Services Scan is preinstalled and/or provided thru Windows Update and will check entitlement on each hardware device to determine if an HP Insights agent-enabled service has been purchased, and will download applicable software automatically. HP Insights agent is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access is required. For full system requirements or to disable this feature, please visit <https://www.hpdaas.com/requirements>.

17. HP Support Assistant is available on Windows. For more information, please visit <https://support.hp.com/us-en/help/hp-support-assistant>.

18. Poly Lens Desktop requires a Windows OS.

19. HP Client Catalog not preinstalled, however available for download at (<https://www.hp.com/us-en/solutions/client-management-solutions.html>).

20. HP Client Management Script Library (<https://www.hp.com/us-en/solutions/client-management-solutions.html#tab=manageability-tools>).

21. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: <https://support.hp.com/us-en/computer>.

22. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

23. HP Image Assistant not preinstalled, however available for download at (<https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPIA.html>),

24. HP Manageability Integration Kit not preinstalled, however available for downloaded from <https://www.hp.com/us-en/solutions/client-management-solutions.html#tab=manageability-tools>.

25. HP Power Manager with Battery Health can be downloaded by entering your system information here: https://support.hp.com/in-en/document/ish_4449597-3519507-16.

26. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and



Features

- requires 8 GB or more system memory. Secured-core PC is enabled from the factory.
27. HP Wolf Security for Business requires Windows 10 or 11 Pro or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features.
28. HP Sure Admin requires HP G8 or newer platforms, Windows 10 or higher, HP BIOS, HP Manageability Kit or KMS Service from <http://www.hp.com/go/clientmanagement> and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
29. HP Sure Click requires Windows 10 and higher. See https://bit.ly/2PrLT6A_SureClick for complete details.
30. HP Sure Recover is available on select HP PCs and requires Windows 10 or 11 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover Gen6 with Embedded Reimaging is an optional feature on select HP PCs which requires Windows 10 or 11 must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data.
31. HP Sure Run is available on select HP PCs and requires Windows 10 and higher.
32. HP Sure Sense requires Windows 10 and higher. See product specifications for availability. On units with WWAN shipping to China, HP Sure Sense is only available via Softpaq download.
33. HP Sure Start is available on select HP PCs and requires Windows 10 and higher.
34. Absolute Persistence firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:
<https://www.absolute.com/about/legal/agreements/absolute/>.
35. HP Fingerprint Reader is an optional feature that requires Windows 10 or 11 and must be configured at purchase.
36. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
37. HP Secure Erase implements the methods outlined in the National Institute of Standards and Technology Special Publication 800-88r "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.



Features

POWER

HP 140W Slim USB Type-C® AC power adapter
HP 100W Slim USB Type-C® AC power adapter
HP 65W Standard USB Type-C® AC power adapter
HP 65W Slim USB Type-C® AC power adapter
HP 65W Standard USB Type-C® Halogen Free AC power adapter

Battery

HP Long Life 3 cell, 62Whr Polymer
HP Long Life 8 cell, 77Whr Polymer

Power Cord

3-wired plug- 1.0m

Battery life

TBD

WEIGHT & DIMENSIONS

Weight

Product Weight- 62Whr

Starting at 1.43 kg
Starting at 3.15 lb

Product Weight- 77Whr

TBD

Product Dimensions (w x d x h)

31.56 x 22.2 x 1.89 cm
12.29 x 8.48 x 0.73 in



Features

PORTS/SLOTS

Left Side

- 2 x Thunderbolt™ 4 with USB Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 2.1) [40]
- 1 x HDMI 2.1
- 1 x headphone/mic combo jack
- 1 x Smart Card Reader (Optional)

Right Side

- 1 x USB Type-C® 20Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)
- 1 x USB Type-A 5Gbps signaling rate (Powered)
- 1 x RJ45 Ethernet port (Optional)
- 1 x Nano SIM card slot (Optional)
- 1 x Security lock slot (Integrated)

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>. [53]

Certification and Compliance

- CSA/UL 62368-1
- ENERGY STAR®
- FCC/ICES/CISPR/VCCI
- CE MARKING
- GS Mark
- China CCC/SRRC
- Taiwan BSMI/NCC
- Korea KCC/KC/KES
- Ukraine NSoC/TEC
- EAEU Compliance
- Saudi Arabian Compliance
- TCO
- EPEAT® Gold¹
- Low Blue Light

¹EPEAT® registered where applicable. EPEAT® registration varies by country. See www.epeat.net for registration status by country.



Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 20.0V

Average Operating Power

Integrated graphics

Intel® Graphics / Intel® Arc™ Pro Graphics

Discrete Graphics

NVIDIA® RTX 500 Ada

Max Operating Power

Discrete < 140W

UMA < 100W

Temperature

Operating

0° to 35° C (32° to 95° F)

System performance may be reduced above 32°C (89.6°F)

-20° to 60° C (-4° to 140° F)

System performance may be reduced above 32°C (89.6°F)

Relative Humidity

Operating

10% to 90 % (non-condensing)

5% to 95 %, 38.7° C (101.6° F) maximum wet bulb temperature

Shock

40 G, 2 ms, half-sine

240 G, 2 ms, half-sine

Random Vibration

1.043 grms

3.500 grms

Altitude (unpressurized)

3048 m (10000 ft)

12192 m (40000 ft)

Planned Industry Standard Certifications

HSN-I62C-4

Regulatory Model Number



Technical Specifications – Displays

DISPLAYS

Actual brightness will be lower with touchscreen or HP Sure View.

Availability may vary by country

14.0 in 2.5K (2560 x 1600)

Anti-Glare UWVA WLED+LBL

AD-100 400 eDP 1.4+PSR2

120Hz (VRR) bent LCD Panel

Outline Dimensions (W x H x D)	306.890 x 197.900 (max)
Active Area	301.594 x 188.496 (typ)
Weight	200 (max)
Diagonal Size	14
Thickness	2.0 / 3.8 (max)
Interface	eDP1.4
Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	2000:1 (typ)
Refresh Rate	120 (typ)
Brightness	400 (typ)
Pixel Resolution - Format	2560 x 1600 (2.5K)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	Adobe RGB 100% + DCI-P3 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.3 (max)/ 2.7 (max)

14.0 in WUXGA (1920 x 1200)

Anti-Glare UWVA LED sRGB

62.5 8bit 300 eDP 1.2 w/o PSR

Low-Power 60Hz bent LCD

Panel

Outline Dimensions (W x H x D)	307.590 x 199.150 (max)
Active Area	301.59 X 188.50(typ)
Weight	300 (max)
Diagonal Size	14
Thickness	3.0/4.8 (max)
Interface	eDP1.2
Surface Treatment	Anti-Glare
Touch Enabled	No



Technical Specifications – Displays

Contrast Ratio	1000 : 1 (typ)
Refresh Rate	60 (typ)
Brightness	300 (typ)
Pixel Resolution - Format	1920 x 1200 (WUXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 62.5%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	No
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.70 (max)/2.10(max)

14.0 in WUXGA (1920 x 1200)

Anti-Glare UWVA LED sRGB

62.5 8bit 300 TOP eDP 1.2 w/o

PSR Low-Power 60Hz bent LCD

Panel

Outline Dimensions (W x H x D)	307.59 x 199.15 (max)
Active Area	301.590 x 188.500 (typ)
Weight	300 (max)
Diagonal Size	14
Thickness	3.0/4.8 (max)
Interface	eDP 1.2
Surface Treatment	Anti-Glare
Touch Enabled	Yes
Contrast Ratio	1000:1(typ)
Refresh Rate	60 (typ)
Brightness	300 (typ)
Pixel Resolution - Format	1920 x 1200 (WUXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 62.5%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	No
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.75 (max) / 2.15 (max)

14.0 in WUXGA (1920 x 1200)

Anti-Glare UWVA Low Blue

Light sRGB 100 800 eDP



Technical Specifications – Displays

1.4+PSR+IOL Sure View 5 bent

LCD Panel

Outline Dimensions (W x H x D)	306.890 x 197.900 (max)
Active Area	301.590 X 188.500 (typ)
Weight	260 (max)
Diagonal Size	14
Thickness	2.2/ 3.9 (max)
Interface	eDP 1.4
Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	1500 : 1 (typ)
Refresh Rate	60 (typ)
Brightness	800 (typ)
Pixel Resolution - Format	1920 x 1200 (WUXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.48 (max)/1.8(max)

14.0 in WUXGA (1920 x 1200)

Anti-Glare UWVA Low Blue

Light sRGB 100 800 TOP eDP

1.4+PSR+IOL Sure View 5 bent

LCD Panel

Outline Dimensions (W x H x D)	306.890 x 197.900 (max)
Active Area	301.590 X 188.500 (typ)
Weight	260 (max)
Diagonal Size	14
Thickness	2.4 / 4.2 (max)
Interface	eDP 1.4
Surface Treatment	Anti-Glare
Touch Enabled	Yes
Contrast Ratio	1500 : 1 (typ)
Refresh Rate	60 (typ)
Brightness	800 (typ)
Pixel Resolution - Format	1920 x 1200 (WUXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 100%



Technical Specifications – Displays

Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.60 (max)/ 1.97 (max)

14.0 in WUXGA (1920 x 1200)

Anti-Glare UWVA WLED+LBL

sRGB NB2X 400 eDP 1.4+PSR2

Low-Power 100 bent LCD Panel

Outline Dimensions (W x H x D)	307.590 x 199.550 (max)
Active Area	301.590 x 188.500 (typ)
Weight	210 (max)
Diagonal Size	14
Thickness	2.0 / 3.8 (max)
Interface	eDP 1.4
Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	1000:1(typ)
Refresh Rate	60 (typ)
Brightness	400 (typ)
Pixel Resolution - Format	1920 x 1200 (WUXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.29 (max) / 1.66 (max)

14.0 in WQXGA DRM (2560 x

1600) Anti-Glare UWVA LED

DCI-P3 NB2X 500 eDP

1.4+PSR2 100 120Hz bent LCD

Panel

Outline Dimensions (W x H x D)	307.594 x 199.546 (max)
Active Area	301.594 x 188.496 (typ)
Weight	230 (max)
Diagonal Size	14
Thickness	2.0 / 3.8 (max)
Interface	eDP 1.4



Technical Specifications – Displays

Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	1200:1(typ)
Refresh Rate	120 (typ)
Brightness	500 (typ)
Pixel Resolution - Format	2560 x1600 (WQXGA)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	DCI-P3 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	No
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.88 (max) / 3.44 (max)



Technical Specifications – Storage

STORAGE

SSD 2TB 2280 PCIe-4x4 NVMe

Three Layer Cell

Form Factor	M.2 2280
Capacity	2TB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	6400 MB/s ±20%
Maximum Sequential Write	5000 MB/s ±20%
Logical Blocks	4000797360
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe

Three Layer Cell

Form Factor	M.2 2280
Capacity	1TB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	6400 MB/s ±20%
Maximum Sequential Write	5000 MB/s ±20%
Logical Blocks	2000409264
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe-4x4

NVMe Three Layer Cell

Form Factor	M.2 2280
Capacity	512GB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4



Technical Specifications – Storage

Maximum Sequential Read	6400 MB/s ±20%
Maximum Sequential Write	3500 MB/s ±20%
Logical Blocks	1000215215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME

Self Encrypted OPAL2 Three Layer Cell Solid State Drive

Form Factor	M.2 2280
Capacity	512GB
NAND Type	TLC
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	6400 MB/s ±20%
Maximum Sequential Write	3500 MB/s ±20%
Logical Blocks	1000215215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	TCG Opal 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe NVMe Value

Form Factor	M.2 2280
Capacity	1TB
NAND Type	Value
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	3500 MB/s ±20%
Maximum Sequential Write	2700 MB/s ±20%
Logical Blocks	2000409264
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe

Value

Form Factor	M.2 2280
Capacity	512 GB
NAND Type	Value



Technical Specifications – Storage

Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	3500 MB/s ±20%
Maximum Sequential Write	1600 MB/s ±20%
Logical Blocks	1000215215
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe

Value

Form Factor	M.2 2280
Capacity	256 GB
NAND Type	Value
Height	0.09 in (2.3 mm)
Width	0.87 in (22 mm)
Weight	0.02 lb (10 g)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	3100 MB/s ±20%
Maximum Sequential Write	1200 MB/s ±20%
Logical Blocks	500118192
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0; TRIM; L1.2



Technical Specifications – Networking

NETWORKING / COMMUNICATION

Intel® AX211 Wi-Fi 6E

Bluetooth® 5.3 vPro® WLAN [1]

Wireless LAN Standards	IEEE 802.11a IEEE 802.11ac IEEE 802.11ax IEEE 802.11b IEEE 802.11d IEEE 802.11e IEEE 802.11g IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11n IEEE 802.11r IEEE 802.11v
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n/ax 2.402 – 2.482 GHz 802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
Modulation	Direct Sequence Spread Spectrum 1024QAM, 16-QAM, 256-QAM, 64-QAM, BPSK, CCK, Direct Sequence Spread Spectrum, OFDM, QPSK
Security	802.1x authentication AES-CCMP: 128 bit in hardware IEEE 802.11i IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only WAPI WPA, WPA2: 802.1x, WPA-PSK, WPA2-PSK, TKIP, and AES.



Technical Specifications – Networking

Network Architecture Models	WPA2 certification WPA3 (personal) certification Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power	<ul style="list-style-type: none">• 802.11b : +17dBm minimum• 802.11g : +16dBm minimum• 802.11a : +17dBm minimum• 802.11n HT20(2.4GHz) : +14dBm minimum• 802.11n HT40(2.4GHz) : +13dBm minimum• 802.11n HT20(5GHz) : +14dBm minimum• 802.11n HT40(5GHz) : +13dBm minimum• 802.11ac VHT80(5GHz) : +10dBm minimum• 802.11ac VHT160(5GHz) : +10dBm minimum• 802.11ax HE40(2.4GHz) : +12dBm minimum• 802.11ax HE80(5GHz) : +10dBm minimum• 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	Transmit mode : 2.0 W Receive mode : 1.6 W Idle mode (PSP) : 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby : 10 mW Radio disabled : 8 mW
Power Management	ACPI and PCI Express compliant power management
Receiver Sensitivity[2]	<ul style="list-style-type: none">• 802.11b, 1Mbps : -93.5dBm maximum• 802.11b, 11Mbps : -84dBm maximum• 802.11a/g, 6Mbps : -86dBm maximum• 802.11a/g, 54Mbps : -72dBm maximum• 802.11n, MCS07 : -67dBm maximum• 802.11n, MCS15 : -64dBm maximum• 802.11ac, MCS0(VHT80) : -84dBm maximum• 802.11ac, MCS9(VHT80) : -59dBm maximum• 802.11ac, MCS9(VHT160) : -58.5dBm maximum• 802.11ax, MCS11(HE40): -57dBm maximum• 802.11ax, MCS11(HE80): -54dBm maximum• 802.11ax, MCS11(HE160): -53.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity Two embedded tri-band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	2.30 x 22.00 x 30.00 mm (0.09 x 0.87 x 1.18 inch)
Weight	1. Type 2230: 2.8 g 2. Type 1216: g



Technical Specifications – Networking

Operating Voltage	3.3 v +/- 9 %
Subtitle	Integrated Bluetooth specifications
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249, 15.407; ETSI 300 328, ETSI 301 893, ETSI 303 687
Bluetooth Profiles Supported	2Mbps LE Advanced Audio Distribution Profile (A2DP) Basic Imaging Profile (BIP) Bluetooth 4.1 -ESR 5/6/7 Compliance Bluetooth 4.2 ESR08 Compliance Bluetooth 5.2 Bluetooth 5.3 wireless card Channel Selection Algo ESR9/10 Compliance FAX Profile (FAX) Hands Free Profile (HFP) Headset Profile (HSP) LE Advertisement Extensions LE Data Packet Length Extension LE Dual Mode LE L2CAP Connection Oriented Channels LE Link Layer LE Link Layer Ping LE Long Range LE Low Duty Cycle Directed Advertising LE Privacy 1.2 –Extended Scanner Filter Policies



Technical Specifications – Networking

LE Privacy 1.2 –Link Layer Privacy
LE Secure Connection- Basic/Full
Limited High Duty Cycle Non-Connectable Advertising
Train Nudging & Interlaced Scan

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately.

2. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® AX211 Wi-Fi 6E

Table Values

Bluetooth® 5.3 WW WLAN [1]

Wireless LAN Standards

IEEE 802.11a
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11b
IEEE 802.11d
IEEE 802.11e
IEEE 802.11g
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11n
IEEE 802.11r
IEEE 802.11v

Interoperability Frequency Band

Wi-Fi certified
802.11b/g/n/ax
2.402 – 2.482 GHz
802.11a/n/ac/ax
4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz
5.47 – 5.725 GHz
5.825 – 5.850 GHz
5.955 – 6.415 GHz
6.435 – 6.515 GHz
6.535 – 6.875 GHz
6.895 – 7.115 GHz

Data Rates

802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11b: 1, 2, 5.5, 11 Mbps
802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps



Technical Specifications – Networking

Modulation	Direct Sequence Spread Spectrum 1024QAM, 16-QAM, 256-QAM, 64-QAM, BPSK, CCK, Direct Sequence Spread Spectrum, OFDM, QPSK
Security	802.1x authentication AES-CCMP: 128 bit in hardware IEEE 802.11i IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only WAPI WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power	<ul style="list-style-type: none">• 802.11b : +17dBm minimum• 802.11g : +16dBm minimum• 802.11a : +17dBm minimum• 802.11n HT20(2.4GHz) : +14dBm minimum• 802.11n HT40(2.4GHz) : +13dBm minimum• 802.11n HT20(5GHz) : +14dBm minimum• 802.11n HT40(5GHz) : +13dBm minimum• 802.11ac VHT80(5GHz) : +10dBm minimum• 802.11ac VHT160(5GHz) : +10dBm minimum• 802.11ax HE40(2.4GHz) : +12dBm minimum• 802.11ax HE80(5GHz) : +10dBm minimum• 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	Transmit mode : 2.0 W Receive mode : 1.6 W Idle mode (PSP) : 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby : 10 mW Radio disabled : 8 mW
Power Management	ACPI and PCI Express compliant power management
Receiver Sensitivity[2]	<ul style="list-style-type: none">• 802.11b, 1Mbps : -93.5dBm maximum• 802.11b, 11Mbps : -84dBm maximum• 802.11a/g, 6Mbps : -86dBm maximum• 802.11a/g, 54Mbps : -72dBm maximum• 802.11n, MCS07 : -67dBm maximum• 802.11n, MCS15 : -64dBm maximum• 802.11ac, MCS0(VHT80) : -84dBm maximum• 802.11ac, MCS9(VHT80) : -59dBm maximum• 802.11ac, MCS9(VHT160) : -58.5dBm maximum• 802.11ax, MCS11(HE40): -57dBm maximum



Technical Specifications – Networking

Antenna type	• 802.11ax, MCS11(HE80): -54dBm maximum • 802.11ax, MCS11(HE160): -53.5dBm maximum High efficiency antenna with spatial diversity
Form Factor	PCI-Express M.2 MiniCard
Dimensions	2.30 x 22.00 x 30.00 mm (0.09 x 0.87 x 1.18 inch)
Weight	1. Type 2230: 2.8 g 2. Type 1216: g
Operating Voltage	3.3 v +/- 9 %
Subtitle	Integrated Bluetooth specifications
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249, 15.407; ETSI 300 328, ETSI 301 893, ETSI 303 687
Bluetooth Profiles Supported	2Mbps LE Advanced Audio Distribution Profile (A2DP) Basic Imaging Profile (BIP) Bluetooth 4.1 -ESR 5/6/7 Compliance Bluetooth 4.2 ESR08 Compliance Bluetooth 5.2 Bluetooth 5.3 wireless card Channel Selection Algo Encryption key size control enhancements ESR9/10 Compliance FAX Profile (FAX)



Technical Specifications – Networking

Hands Free Profile (HFP)
Headset Profile (HSP)
LE Advertisement Extensions
LE Data Packet Length Extension
LE Dual Mode
LE L2CAP Connection Oriented Channels
LE Link Layer
LE Link Layer Ping
LE Long Range
LE Low Duty Cycle Directed Advertising
LE Privacy 1.2 –Extended Scanner Filter Policies
LE Privacy 1.2 –Link Layer Privacy
LE Secure Connection- Basic/Full
Limited High Duty Cycle Non-Connectable Advertising
Periodic Advertisement interval
Train Nudging & Interlaced Scan
Windows Bluetooth profiles support

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately.

2. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® BE201 Wi-Fi 7

Table Values

Bluetooth® 5.4 non-vPro® WW

WLAN [1]

Wireless LAN Standards	
IEEE 802.11a	
IEEE 802.11ac	
IEEE 802.11ax	
IEEE 802.11b	
IEEE 802.11be	
IEEE 802.11d	
IEEE 802.11e	
IEEE 802.11g	
IEEE 802.11h	
IEEE 802.11i	
IEEE 802.11k	
IEEE 802.11n	
IEEE 802.11r	
IEEE 802.11v	
Interoperability	Wi-Fi certified



Technical Specifications – Networking

Frequency Band	802.11b/g/n/ax 2.402 – 2.482 GHz
	802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, 80MHz, 160MHz) 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, 80MHz, 160MHz) 802.11b: 1, 2, 5.5, 11 Mbps 802.11be : MCS0~13, (20MHz, 40MHz, ,80MHz, 160MHz, 320MHz) 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, 40MHz)
Modulation	Direct Sequence Spread Spectrum 1024QAM, 16-QAM, 256-QAM, 4096QAM, 64-QAM, BPSK, CCK, Direct Sequence Spread Spectrum, OFDM, QPSK
Security[3]	802.1x authentication AES-CCMP: 128 bit in hardware IEEE 802.11i IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only WAPI WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power[2]	<ul style="list-style-type: none">• 802.11b, 1Mbps : +17dBm minimum• 802.11g, 6Mbps : +16dBm minimum• 802.11a, 6Mbps : +17dBm minimum• 802.11n, MCS7(HT20) : +14dBm minimum• 802.11n, MCS7(HT40) : +13.5dBm minimum• 802.11ac MCS9(VHT20) : 13.5dBm minimum• 802.11ac MCS9(VHT40) : +13.5dBm minimum• 802.11ac MCS9(VHT80) : +12.5dBm minimum• 802.11ac MCS9(VHT160) : +10.5dBm minimum• 802.11ax MCS11(HE20)(6GHz) : +11.5dBm minimum



Technical Specifications – Networking

Power Consumption	<ul style="list-style-type: none">• 802.11ax MCS11(HE40)(6GHz) : +7.5dBm minimum• 802.11ax MCS11(HE80)(6GHz) : +7.5dBm minimum• 802.11ax MCS11(HE160)(6GHz) : +7.5dBm minimum• 802.11be MCS13(EHT20)(6GHz) : 11.5dBm• 802.11be MCS13(EHT40)(6GHz) : 7.5dBm• 802.11be MCS13(EHT80)(6GHz) : 7.5dBm• 802.11be MCS13(EHT160)(6GHz) : 6.5dBm• 802.11be MCS13(EHT320)(6GHz) : 4.5dBm <p>Transmit mode : 3.4 W Receive mode : 1.8 W Idle mode (PSP) : 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby : 10 mW Radio disabled : 8 mW</p>
Power Management	ACPI and PCI Express compliant power management
Receiver Sensitivity[3]	<ul style="list-style-type: none">• 802.11b, 1Mbps : -93.5dBm maximum• 802.11b, 11Mbps : -85dBm maximum• 802.11a/g, 6Mbps : -90.5dBm maximum• 802.11a/g, 54Mbps : -72.5dBm maximum• 802.11n, MCS0(HT20) : -90dBm maximum• 802.11n, MCS7(HT20) : -71.5dBm maximum• 802.11n, MCS0(HT40) : -88.5dBm maximum• 802.11n, MCS7(HT40) : -68.5dBm maximum• 802.11ac, MCS9(VHT20) : -88.5dBm maximum• 802.11ac, MCS9(VHT40) : -65.5dBm maximum• 802.11ac, MCS9(VHT80) : -60.5dBm maximum• 802.11ac, MCS9(VHT160) : -58.5dBm maximum• 802.11ax, MCS11(HE20)(6GHz) : -59.5dBm maximum• 802.11ax, MCS11(HE40)(6GHz) : -56.5dBm maximum• 802.11ax, MCS11(HE80)(6GHz) : -53.5dBm maximum• 802.11ax, MCS11(HE160)(6GHz) : -51.5dBm maximum• 802.11be, MCS13(EHT20)(6GHz) : -55.5dBm maximum• 802.11be, MCS13(EHT40)(6GHz) : -53.5dBm maximum• 802.11be, MCS13(EHT80)(6GHz) : -51.5dBm maximum• 802.11be, MCS13(EHT160)(6GHz) : -48.5dBm maximum• 802.11be, MCS13(EHT320)(6GHz) : -45.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity Two embedded tri-band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Dimensions	30.00 x 22.00 x 2.30 mm (1.18 x 0.87 x 0.09 inch)
Weight	1. Type 2230: 3.1 g 2. Type 1216: 0.8 g



Technical Specifications – Networking

Operating Voltage	3.3 v +/- 5 %
Subtitle	Integrated Bluetooth specifications
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Compliant
Frequency Band	2042 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249, 15.407; ETSI 300 328, ETSI 301 893, ETSI 303 687
Bluetooth Profiles Supported	2Mbps LE Advanced Audio Distribution Profile (A2DP) Basic Imaging Profile (BIP) Bluetooth 4.1 -ESR 5/6/7 Compliance Bluetooth 4.2 ESR08 Compliance Bluetooth 5.2 Bluetooth 5.3 wireless card Channel Selection Algo Encryption key size control enhancements ESR9/10 Compliance FAX Profile (FAX) Hands Free Profile (HFP) Headset Profile (HSP) LE Advertisement Extensions LE Data Packet Length Extension LE Dual Mode LE L2CAP Connection Oriented Channels LE Link Layer LE Link Layer Ping LE Long Range LE Low Duty Cycle Directed Advertising



Technical Specifications – Networking

LE Privacy 1.2 –Extended Scanner Filter Policies
LE Privacy 1.2 –Link Layer Privacy
LE Secure Connection- Basic/Full
Limited High Duty Cycle Non-Connectable Advertising
Periodic Advertisement interval
Train Nudging & Interlaced Scan
Windows Bluetooth profiles support

1.Wi-Fi 7 requires a Wi-Fi 7 router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 7 is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 7 is supported. Wi-Fi 7 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® BE201 Wi-Fi 7

Table Values

Bluetooth® 5.4 vPro® WW

WLAN [1]

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11ac
	IEEE 802.11ax
	IEEE 802.11b
	IEEE 802.11be
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11g
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11n
	IEEE 802.11r
	IEEE 802.11v
Interoperability Frequency Band	Wi-Fi certified
	802.11b/g/n/ax
	2.402 – 2.482 GHz
	802.11a/n/ac/ax
	4.9 – 4.95 GHz (Japan)
	5.15 – 5.25 GHz
	5.25 – 5.35 GHz
	5.47 – 5.725 GHz
	5.825 – 5.850 GHz
	5.955 – 6.415 GHz
	6.435 – 6.515 GHz



Technical Specifications – Networking

Data Rates	6.535 – 6.875 GHz 6.895 – 7.115 GHz
Modulation	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, 80MHz, 160MHz) 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, 80MHz, 160MHz) 802.11b: 1, 2, 5.5, 11 Mbps 802.11be : MCS0~13, (20MHz, 40MHz, ,80MHz, 160MHz, 320MHz) 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, 40MHz)
Security	Direct Sequence Spread Spectrum 1024QAM, 16-QAM, 256-QAM, 4096QAM, 64-QAM, BPSK, CCK, Direct Sequence Spread Spectrum, OFDM, QPSK 802.1x authentication AES-CCMP: 128 bit in hardware IEEE 802.11i IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only WAPI WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power	<ul style="list-style-type: none">• 802.11b, 1Mbps : +17dBm minimum• 802.11g, 6Mbps : +16dBm minimum• 802.11a, 6Mbps : +17dBm minimum• 802.11n, MCS7(HT20) : +14dBm minimum• 802.11n, MCS7(HT40) : +13.5dBm minimum• 802.11ac MCS9(VHT20) : 13.5dBm minimum• 802.11ac MCS9(VHT40) : +13.5dBm minimum• 802.11ac MCS9(VHT80) : +12.5dBm minimum• 802.11ac MCS9(VHT160) : +10.5dBm minimum• 802.11ax MCS11(HE20)(6GHz) : +11.5dBm minimum• 802.11ax MCS11(HE40)(6GHz) : +7.5dBm minimum• 802.11ax MCS11(HE80)(6GHz) : +7.5dBm minimum• 802.11ax MCS11(HE160)(6GHz) : +7.5dBm minimum• 802.11be MCS13(EHT20)(6GHz) : 11.5dBm• 802.11be MCS13(EHT40)(6GHz) : 7.5dBm• 802.11be MCS13(EHT80)(6GHz) : 7.5dBm• 802.11be MCS13(EHT160)(6GHz) : 6.5dBm• 802.11be MCS13(EHT320)(6GHz) : 4.5dBm
Power Consumption	Transmit mode : 3.4 W Receive mode : 1.8 W



Technical Specifications – Networking

Power Management	Idle mode (PSP) : 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby : 10 mW Radio disabled : 8 mW
Receiver Sensitivity[2]	ACPI and PCI Express compliant power management <ul style="list-style-type: none">• 802.11b, 1Mbps : -93.5dBm maximum• 802.11b, 11Mbps : -85dBm maximum• 802.11a/g, 6Mbps : -90.5dBm maximum• 802.11a/g, 54Mbps : -72.5dBm maximum• 802.11n, MCS0(HT20) : -90dBm maximum• 802.11n, MCS7(HT20) : -71.5dBm maximum• 802.11n, MCS0(HT40) : -88.5dBm maximum• 802.11n, MCS7(HT40) : -68.5dBm maximum• 802.11ac, MCS9(VHT20) : -88.5dBm maximum• 802.11ac, MCS9(VHT40) : -65.5dBm maximum• 802.11ac, MCS9(VHT80) : -60.5dBm maximum• 802.11ac, MCS9(VHT160) : -58.5dBm maximum• 802.11ax, MCS11(HE20)(6GHz) : -59.5dBm maximum• 802.11ax, MCS11(HE40)(6GHz) : -56.5dBm maximum• 802.11ax, MCS11(HE80)(6GHz) : -53.5dBm maximum• 802.11ax, MCS11(HE160)(6GHz) : -51.5dBm maximum• 802.11be, MCS13(EHT20)(6GHz) : -55.5dBm maximum• 802.11be, MCS13(EHT40)(6GHz) : -53.5dBm maximum• 802.11be, MCS13(EHT80)(6GHz) : -51.5dBm maximum• 802.11be, MCS13(EHT160)(6GHz) : -48.5dBm maximum• 802.11be, MCS13(EHT320)(6GHz) : -45.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity
	Two embedded tri-band 2.4/5/6 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Dimensions	30.00 x 22.00 x 2.30 mm (1.18 x 0.87 x 0.09 inch)
Weight	1. Type 2230: 3.1 g 2. Type 1216: 0.8 g
Operating Voltage	3.3 v +/- 5 %
Subtitle	Integrated Bluetooth specifications
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Compliant
Frequency Band	2042 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy :



Technical Specifications – Networking

Transmit Power	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249, 15.407; ETSI 300 328, ETSI 301 893, ETSI 303 687
Bluetooth Profiles Supported	2Mbps LE Advanced Audio Distribution Profile (A2DP) Basic Imaging Profile (BIP) Bluetooth 4.1 -ESR 5/6/7 Compliance Bluetooth 4.2 ESR08 Compliance Bluetooth 5.2 Bluetooth 5.3 wireless card Channel Selection Algo Encryption key size control enhancements ESR9/10 Compliance FAX Profile (FAX) Hands Free Profile (HFP) Headset Profile (HSP) LE Advertisement Extensions LE Data Packet Length Extension LE Dual Mode LE L2CAP Connection Oriented Channels LE Link Layer LE Link Layer Ping LE Long Range LE Low Duty Cycle Directed Advertising LE Privacy 1.2 –Extended Scanner Filter Policies LE Privacy 1.2 –Link Layer Privacy LE Secure Connection- Basic/Full Limited High Duty Cycle Non-Connectable Advertising Periodic Advertisement interval Train Nudging & Interlaced Scan Windows Bluetooth profiles support



Technical Specifications – Networking

- 1.Wi-Fi 7 requires a Wi-Fi 7 router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 7 is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 7 is supported. Wi-Fi 7 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
2. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP 5G Sub-6 CAT19 [1]

Technology/Operating bands

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)

Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)

Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)

Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)

Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)

Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)

Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)

Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)

Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)

Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 34: 2010 to 2025 MHz (UL/DL)

Band 38: 2570 to 2620 MHz (UL/DL)

Band 39: 1880 to 1920 MHz (UL/DL)

Band 40: 2300 to 2400 MHz (UL/DL)

Band 41: 2496 to 2690 MHz (UL/DL)

Band 42: 3400 to 3600 MHz (UL/DL)

Band 43: 3400 to 3800 MHz (UL/DL)

Band 46: 5150 to 5925 MHz (DL)

Band 48: 3550 to 3700 MHz (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)

Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)



Technical Specifications – Networking

Wireless protocol standards	5GNR Air Interface 3GPP Rel15 5G NR sub-6 LTE Rel15 3GPP Release 8 UMTS Specification
GPS	Standalone/A-GPS (MS-A, MS-B)
GPS bands	GPS L1 (1575.42MHz), GLONASS L1 (1602MHz), Beidou B1 (1561.098MHz), Galileo E1 (1575.42MHz), QZSS (1575.42MHz)
Maximum data rates	SA 5G/NR sub-6 Peak: 4.67 Gbps(Download), 1.25 Gbps(Upload)
Maximum output power	HSPA+: 23.5 dBm LTE (all bands except B41): 23.0 dBm (Not support HPUE) NR (all band except n41, n77, n78, n79): 23.0 dBm (Not support HPUE) NR n41, n77, n78, n79 HPUE: 26.0 dBm (Support HPUE)
Maximum power consumption	5G Sub 6: 3,500 mA LTE: 2,500 mA (peak); mA (average)
Form Factor	M.2; 3052-S3 Key B
Weight	8.6 g (0.303 oz)
Dimensions (Length x Width x Thickness)	30.00 x 52.00 x 2.30 mm (1.18 x 2.05 x 0.09 inch)
embedded eSIM	Yes

1. 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

HP 4G CAT19 [1]

.Technology/Operating bands

WCDMA/HSPA+ operating bands:
Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
LTE FDD/TDD operating bands:
Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)



Technical Specifications – Networking

Wireless protocol standards	Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) Band 29: 717 to 728 MHz (DL) Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHz (UL/DL) Band 43: 3400 to 3800 MHz (UL/DL) Band 46: 5150 to 5925 MHz (DL) Band 48: 3550 to 3700 MHz (UL/DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) LTE Rel15 3GPP Release 8 UMTS Specification Standalone/A-GPS (MS-A, MS-B) GPS L1 (1575.42MHz), GLONASS L1 (1602MHz), Beidou B1 (1561.098MHz), Galileo E1 (1575.42MHz), QZSS (1575.42MHz) UE Category DL 19 (1.6 Gbps Download) , UE Category UL 18 (211 Mbps Upload)
GPS	3GPP Release 8 UMTS Specification
GPS bands	Standalone/A-GPS (MS-A, MS-B) GPS L1 (1575.42MHz), GLONASS L1 (1602MHz), Beidou B1 (1561.098MHz), Galileo E1 (1575.42MHz), QZSS (1575.42MHz)
Maximum data rates	UE Category DL 19 (1.6 Gbps Download) , UE Category UL 18 (211 Mbps Upload)
Maximum output power	LTE (all bands except B41): 23.0 dBm (Not support HPUE)
Maximum power consumption	LTE: 2,500 mA (peak)
Form Factor	M.2; 3052-S3 Key B
Weight	8.4 g (0.296 oz)
Dimensions (Length x Width x Thickness)	30.00 x 52.00 x 2.30 mm (1.18 x 2.05 x 0.09 inch)
embedded eSIM	Yes

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

NFC Mirage WNC XRAV-1

Dimensions (L x W x H)

17.00 x 10.00 x 2.00 mm (0.67 x 0.39 x 0.08 inch)



Technical Specifications – Networking

Chipset	NPC300
System interface	I2C
NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
NFC Forum Support	Type 1, Type 2, Type 3 / Type 4, NFCIP-1 / NFCIP-2
Reader (PCD-VCD) Mode	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz
Card Emulation (PICC-VICC) Mode	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa 13.56 MHz Reader/Writer, Peer-to-Peer
Frequency	106 kbps, 212 kbps, 424 kbps, 848 kbps
NFC Modes Supported	Operating: 0 °C to 70 °C (32 °F to 158 °F)
Raw RF Data Rates	Storage: -20 °C to 125 °C (-4 °F to 257 °F)
Operating temperature	Operating: 10% - 90% (non-condensing) Non-Operating: 5% - 95% (non-condensing)
Storage temperature	Operating: 10% - 90% (non-condensing) Non-Operating: 5% - 95% (non-condensing)
Humidity	4.35 to 5.25 Volts
Supply Operating voltage	1.8V or 3.3V
I/O Voltage	Booster enable, VBAT= 3.3V, VCC_BOOST = 5V
Power Consumption (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V)	Power Consumption, Typical
Mode	7.3 mA
Polling	Total 283.8 mA
Detected Test Tag Type 1	Net Module 236.8 mA
Detected Test Tag Type 2	Total 288.8 mA
Detected Test Tag Type 3	Net Module 241.8 mA
	Total 287.7 mA
	Net Module 240.7 mA



Technical Specifications – Networking

Intel® I219-LM (vPro®) GbE PCIe NIC	Detected Test Tag Type 4	Total 282.3 mA Net Module 235.3 mA
	Antenna	Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module.
	Connector	RJ-45
	System Interface	PCI (Intel proprietary) + SMBus
	Data rates supported	1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 40) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
	IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)
	Performance	TCP/IP/UDP Checksum offload (configurable) Protocol offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling (Hash Mode Only) Jumbo Frame 9K
	Power consumption	Cable Disconnection: 25 mW 100Mbps Full Run: 450 mW 1000Mbps Full Run: 1000 mW WoL Enable(S3/S4/S5): 50 mW WoL Disable(S3/S4/S5): 25 mW
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Management Interface	Auto MDI/MDIX Crossover cable detection
	IT Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame) Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status Intel® vPro™ support with appropriate Intel® chipset components
	Security & Manageability	



Technical Specifications – Networking

Intel® I219-LM (vPro®) GbE	Connector	RJ-45
PCIe NIC		
	System Interface	PCI(Intel proprietary) + SMBus
	Data rates supported	1. 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 2. 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 3. 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 40) 4. 2.5 Gbit/s operation(2.5GBASE-T; IEEE 802.3bz Clause 126) 5. Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10& 100 Mbit/s
	IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31 -32; configurable) IEEE 802.3i 10BASE-T IEEE 802.3u 100BASE-TX IEEE 802.3ab 1000BAE-T IEEE 802.3bz 2.5GBASE-T
	Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling(Hash Mode Only) Jumbo Frame 9K
	Power consumption	Cable Disconnection: 25mW 100Mbps Full Run: 450mW 1000Mbp Full Run: 1000mW 2500Mbp Full Run: 4500mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Management Interface	Auto MDI/MDIX Crossover cable detection
	IT Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status



Technical Specifications – Networking

Security & Manageability		Intel® non-vPro™ support with appropriate Intel® chipset components
Qualcomm 9205 LTE-M (CAT-M1 fSVC) [1]	Technology/Operating bands	FDD LTE: 1700/2100 (Band 4), 1700/2100 (Band 66), 1800 (Band 3), 1900 (Band 2), 1900 (Band 25), 2100 (Band 1), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 28), 700 (band 85), 800 (Band 20), 800 (Band 27), 850 (Band 18 lower), 850 (Band 19 upper), 850 (Band 26), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	GSM/GPRS/EGPRS: 1800, 1900, 850, 900 MHz 3GPP TS 21.111 V10.0.0: USIM and IC card requirements 3GPP TS 27.005 V10.0.1: Use of Data Terminal Equipment - Data Circuit terminating Equipment (DTE - DCE) interface for Short Message Service (SMS) and Cell Broadcast Service (CBS) 3GPP TS 27.007 V10.0.8: AT command set for User Equipment (UE) 3GPP TS 31.102 V10.11.0: Characteristics of the Universal Subscriber Identity Module (USIM) application 3GPP TS 31.11 V10.16.0: Universal Subscriber Identity Module (USIM) Application Toolkit (USAT) 3GPP TS 36.124 V10.3.0: Electro Magnetic Compatibility (EMC) requirements for mobile terminals and ancillary equipment 3GPP TS 36.521-1 V14.3.0: User Equipment (UE) conformance specification; Radio transmission and reception; Part 1: Conformance testing 3GPP TS 51.010-1 V10.5.0: Mobile Station (MS) conformance specification; Part 1: Conformance specification 3GPP TS 51.011 V4.15.0: Specification of the Subscriber Identity Module -Mobile Equipment (SIM-ME) interface Standalone GPS/Beidou/GLONASS/A-GPS (XTRA) 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	GPS GPS bands	LTE FDD: 375.00 Kbps(Download), 1119.00 Kbps(Upload) GPRS: 107.00 Kbps(Download), 85.60 Kbps(Upload) EGPRS: 296.00 Kbps(Download), 236.80 Kbps(Upload)
	Maximum data rates	LTE (all bands except B41): 21.5 dBm GSM: 34.0 dBm
	Maximum output power	LTE: 151 mA(peak), 16 mA(average)
	Maximum power consumption	M.2
	Form Factor	4.0 g (0.141 oz)
	Weight	22.00 x 42.00 x 2.30 mm (0.87 x 1.65 x 0.09 inch)
	Dimensions (Length x Width x Thickness)	



Technical Specifications – Networking

embedded eSIM

Support

1. LPWAN (also called Mobile Narrowband) support HP Protect & Trace with Wolf Connect service through the subscription term, but do not support mobile broadband use.



Technical Specifications – Power

POWER

Power supply availability may vary by country.

HP 100W Slim USB-C Straight AC Power Adapter Mario II

Dimensions	5.354 x 2.362 x 0.866 in (13.6x6.0x2.2cm)
Weight	340g ± 10g (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
Input frequency range	47-63Hz
Input AC current	Max. 1.6 A at 90 Vac
Output	5V/15W 9V/27W 12V/60W 15V/75W 20V/100W
DC output	5V/9V/12V/15V/20V
Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
Output current limit	5V/9V/12V/15V<125% max current, 20V<135% max current
Output Over Current Protection	
Connector	C6
Connector	
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1, IEC 62368-1:2014 and IEC62368-1 : 2018, EN62368-1:2020+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, CU(EAC), KCC(Safety+EMC), NOM-001 NYCE, NRCan, NRCS, ISC, SEC, PSB, Argentina S-mark,



Technical Specifications – Power

AC Adapter 65 Watt nPFC
Standard USB type C Straight
1.8m (Ceto)

Australia RCM, BIS, BSMI, UAE, UKCA DoC,
Ukraine(CoC+DoC+RoHS+ECO)

Dimensions	3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm)
Weight	220g ± 10g (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
Input frequency range	47-63Hz
Input AC current	Max. 1.6 A at 90 Vac
Output	
Output power	5V/15W 9V/27W 12V/60W 15V/65W 20V/65W
DC output	5V/9V/12V/15V/20V
Hold-up time	100% load 5ms at 115 Vac input
Output current limit	< 8.0A
Protection	
Connector	
Connector	C6
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan,



Technical Specifications – Power

HP 65W GaN USB-C nPFC

Straight AC Power Adapter

Cappy

Dimensions	2.68 x 2.1 x 0.875 in (6.8x5.3x2.2cm)
Weight	105g ± 10g (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
Input frequency range	47-63Hz
Input AC current	Max. 1.6 A at 90 Vac
Output	
Output power	5V/15W 9V/27W 15V/65W 20V/65W
DC output	5V/9V/15V/20V
Hold-up time	100% load 5ms at 115 Vac input
Output current limit	115%-125%
Output Over Current Protection	
Connector	C6
Connector	
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC



Technical Specifications – Power

HP 65W Slim USB-C Straight AC

Power Adapter Taroko II

Dimensions	3.819 x 2.106 x 0.827 in (9.7x5.35x2.1cm)
Weight	200g ± 10g (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
Input frequency range	47-63Hz
Input AC current	Max. 1.6 A at 90 Vac
Output	
Output power	5V/15W 9V/27W 12V/60W 15V/65W 20V/65W
DC output	5V/9V/12V/15V/20V
Hold-up time	100% load 5ms at 115 Vac input
Output current limit	< 8.0A
Over Current Protection	
Connector	C6
Connector	
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC



Technical Specifications – Power

HP 65W Standard USB-C

Halogen Free Straight AC

Power Adapter Ceto+

Dimensions	3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm)
Weight	220g ± 10g (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V
Input frequency range	47-63Hz
Input AC current	Max. 1.6 A at 90 Vac
Output	5V/15W
Output power	9V/27W 12V/60W 15V/65W 20V/65W
DC output	5V/9V/12V/15V/20V
Hold-up time	100% load 5ms at 115 Vac input
Output current limit	< 8.0A
Protection	
Connector	C6
Connector	
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC



Technical Specifications – Power

HP 140W Slim USB-C Straight

AC Power Adapter Daisy II

Dimensions	5.433 x 2.578 x 1.122 in (13.8x6.55x2.85cm)
Weight	415g(+/-10g) (Not including power cord. Power cord varies by country.)
Input	100-240Vac
Input Efficiency	81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V 89.00% min at 115 Vac/ 230 Vac @28.00V
Input frequency range	47-63Hz
Input AC current	Max. 2.5 A at 90 Vac
Output	5V/15W 9V/27W 12V/60W 15V/75W 20V/100W 28V/140W
DC output	5V/9V/12V/15V/20V/28V
Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
Output current limit	5V/9V/12V/15V/20V<125% max current, 28V<135% max current
Output Over Current	
Protection	
Connector	C6
Connector	
Environmental Design	
Operating temperature	0° to 35° C (32° to 95° F)
Non-operating (storage) temperature	-20° to 85° C (-4° to 185° F)
Altitude	0 to 5,000 m (0 to 16,400 ft)
Humidity	20% to 95%
Storage Humidity	10% to 95%
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1, IEC 62368-1:2014 and IEC62368-1 : 2018, EN62368-1:2020+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, CU(EAC), KCC(Safety+EMC), NOM-001 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC, Ukraine(CoC+DoC+RoHS+ECO)



Technical Specifications – Power

MC 62Whr Long Life Polymer

Fast charge 3 cell Battery

Dimensions (H x W x L)	L 255.8 mm* W 67.8mm* T 7.4mm
Weight	Max 236.0g
Cells/Type	3cell Lithium-Ion Polymer cell
Energy	
Voltage	11.58V
Amp-hour capacity	5355mAh / 5086mAh
Watt-hour capacity	62Whr
Temperature	
Operating (Charging)	0° C ~ 40° C
Operating (Discharging)	-10° C ~ 40° C
Fuel Gauge LED	
Warranty	
Optional Travel Battery Available	No

MW 77Whr Long Life Polymer

Fast charge 8 cell Battery

Dimensions (H x W x L)	L 268 mm* W 73 mm* T 10.06 mm
Weight	Max 300g
Cells/Type	8cell Lithium-Ion Polymer cell
Energy	
Voltage	15.44V
Amp-hour capacity	4988mAh / 4738mAh
Watt-hour capacity	77Whr
Temperature	
Operating (Charging)	0° C ~ 40° C
Operating (Discharging)	-10° C ~ 40° C
Fuel Gauge LED	
Warranty	
Optional Travel Battery Available	No



Technical Specifications – Audio

AUDIO

HD Stereo Codec

Realtek ALC3315

Audio I/O Ports

3.5mm Headset: CTIA only;Headphone-out

Internal Speaker Amplifier

Cirrus Logic High-Efficiency Boosted Class D Amplifier

Multi-streaming Capable

Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front jacks or integrated speaker.,

Following MSFT Behavior

DAC: Supports resolutions from 16-bit to 24-bit;48.0 kHz to 48.0 kHz

ADC: Supports resolutions from 16-bit to 24-bit;44.1 kHz to 48.0 kHz

Sampling

Yes

Internal Speaker



Technical Specifications – Fingerprint Reader

FINGERPRINT READER

Sensor vendor	SYNAPTICS
Sensor type	Capacitive
DPI resolution	363 DPI
Scan area	104 x 86 pixels
False Rejection Rate	< 3%
False Acceptance Rate	< 0.001%
Mobile Voltage Operation	2.7 V ~ 3.6 V
Operating Temperature	5°C ~ 60°C (41°F ~ 140°F)
Current Consumption Image	100 mA max
Low Latency Wait For Finger	260 uA
Capture Rate	50 frames/sec
ESD Resistance	IEC 61000-4-2 4B (+15KV)
Detection Matrix	363 dpi / 7.4 x 6.0 mm sensor area

Fingerprint Reader

Sensor vendor	ELAN
Sensor type	Capacitive
DPI resolution	363 DPI
Scan area	56 x 56 pixels
False Rejection Rate	< 3%
False Acceptance Rate	< 0.001%
Mobile Voltage Operation	2.8 V ~ 3.6 V
Operating Temperature	-20°C ~ 80°C (-4°F ~ 176°F)
Current Consumption Image	100 mA max
Low Latency Wait For Finger	300 uA
Capture Rate	50 frames/sec
ESD Resistance	IEC 61000-4-2 4B (+15KV)
Detection Matrix	363 dpi / 4.0 x 4.0 mm sensor area



Options and Accessories (sold separately and availability may vary by country)

OPTIONS

Category	Description	Part Number
Audio/Video	TBD	TBD
Cases	TBD	TBD
Docking	TBD	TBD
Hub	TBD	TBD
Adapter	TBD	TBD
Keyboard/Combo	TBD	TBD
Mouse	TBD	TBD
Power	TBD	TBD
Commodity	TBD	TBD



Date of change	Version History	Description of change
	From v1 to v2	

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